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Kingbright BC56-12CGKWA

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>



14.22mm (0.56INCH) THREE DIGIT NUMERIC DISPLAY

The Green source color devices are made with AlGaInP on

Part Number: BC56-12CGKWA Green

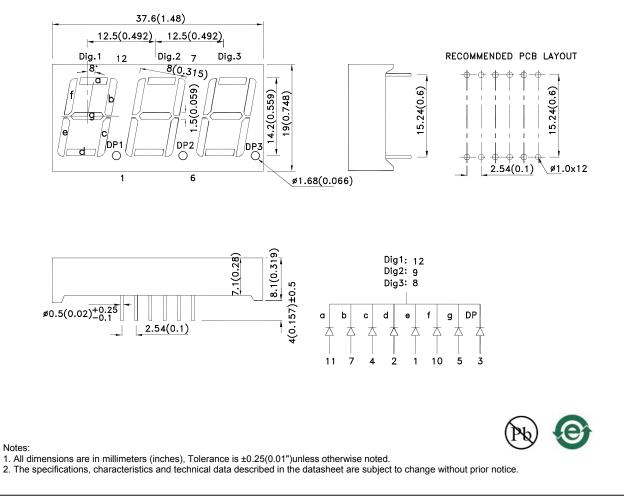
GaAs substrate Light Emitting Diode.

Description

Features

- 0.56 inch digit height.
- Low current operation.
- Excellent character appearance.
- Easy mounting on P.C. boards or sockets.
- Mechanically rugged.
- Standard: gray face, white segment.
- RoHS compliant.

Package Dimensions& Internal Circuit Diagram





Selection Guide

	Part No.	Dice	Lens Type	lv (ucd) [1] @ 10mA		Description					
				Min.	Тур.						
	BC56-12CGKWA	Green (AlGaInP)	White Diffused	14000	35000	Common Cathode ,Rt. Hand Decimal.					
				*5600	*11000						

Notes:

1. Luminous intensity/ luminous Flux: +/-15%. * Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	574		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Green	570		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Green	20		nm	I⊧=20mA
С	Capacitance	Green	15		pF	VF=0V;f=1MHz
Vf [2]	Forward Voltage	Green	2.1	2.5	V	I⊧=20mA
IR	Reverse Current	Green		10	uA	VR=5V

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

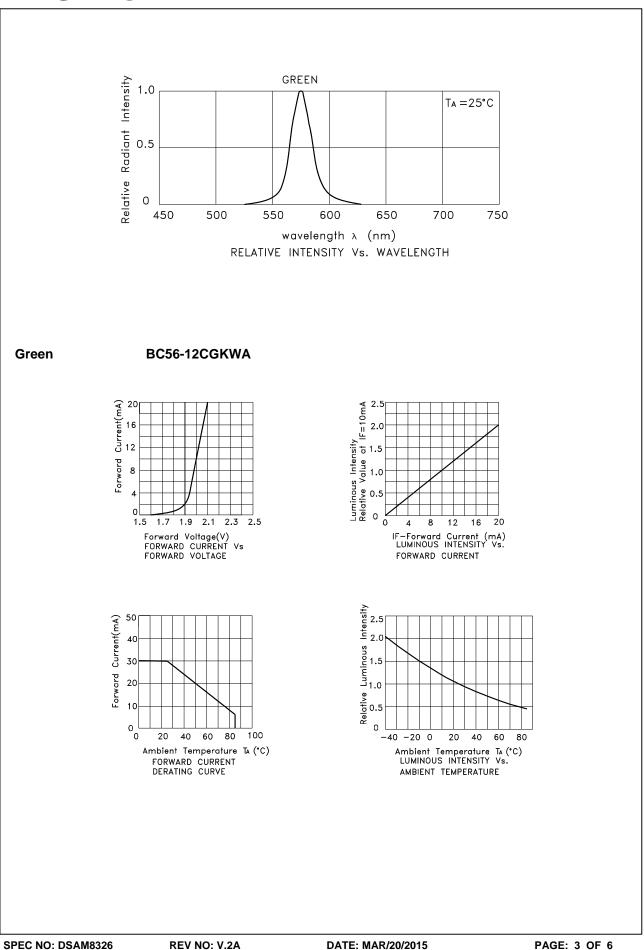
Parameter Green Units Power dissipation 75 mW DC Forward Current 30 mΑ Peak Forward Current [1] 150 mΑ V **Reverse Voltage** 5 Operating / Storage Temperature -40°C To +85°C Lead Solder Temperature[2] 260°C For 3-5 Seconds

Notes:

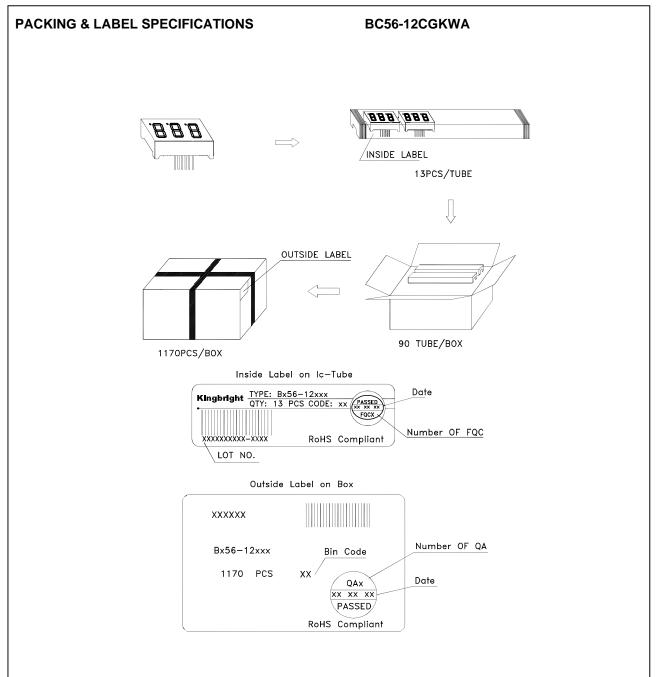
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.





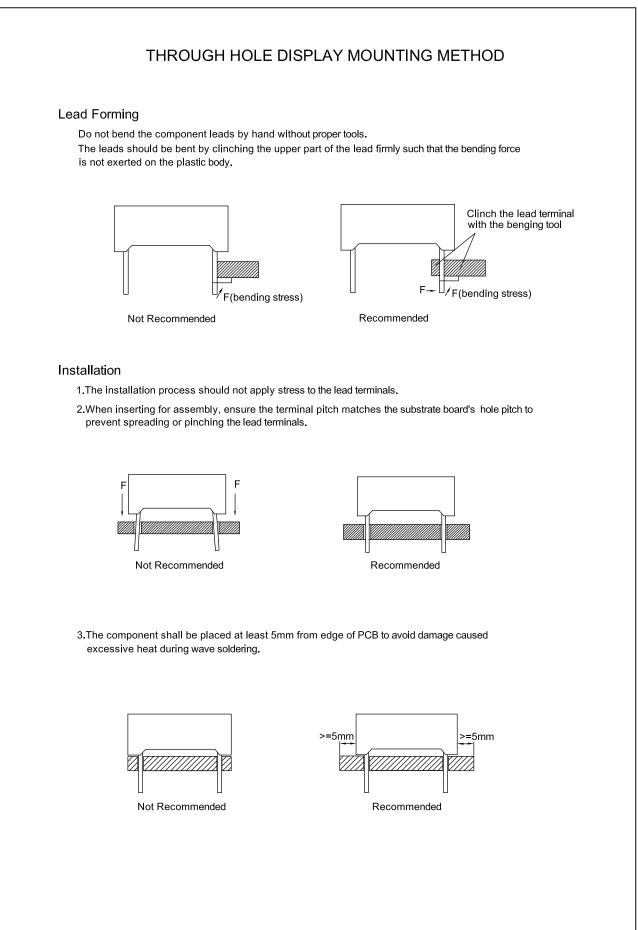




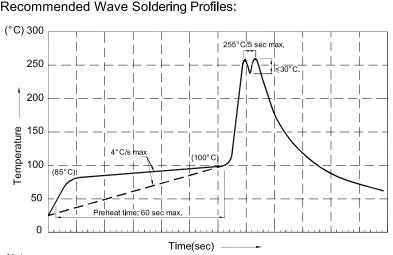
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Notes:

- Recommend pre-heat temperature of 105° C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260° C
- 2 Peak wave soldering temperature between 245° C \sim 255° C for 3 sec (5 sec max).
- 3.Do not apply stress to the epoxy resin while the temperature is above $85^\circ\text{C}.$
- 4. Fixtures should not incur stress on the component when mounting and during soldering process.
- 5.SAC 305 solder alloy is recommended.
- 6.No more than one wave soldering pass.
- 7.During wave soldering, the PCB top-surface temperature should be kept below 105°C.

Soldering General Notes:

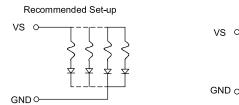
- 1. Through-hole displays are incompatible with reflow soldering.
- 2.If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

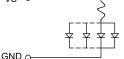
CLEANING

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- 2. If cleaning is required, Kingbright recommends to wash components with water only.
- Do not use harsh organic solvents for cleaning because they may damage the plastic parts .
- 3. The cleaning process should take place at room temperature and the devices should not be washed for more than one minute.
- 4.When water is used in the cleaning process, immediately remove excess moisture from the component with forced-air drying afterwards.

CIRCUIT DESIGN NOTES

- 1.Protective current-limiting resistors may be necessary to operate the LEDs within the specified range.
- 2.LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.





invalid Set-up

- 3. The driving circuit should be designed to protect the LED against reverse voltages and transient voltage spikes when the circuit is powered up or shut down.
- 4. The safe operating current should be chosen after considering the maximum ambient temperature of the operating environment.
- 5. Prolonged reverse bias should be avoided, as it could cause metal migration, leading to an increase in leakage current or causing a short circuit.